# The SN54165 and SN74165 devices are obsolete and are no longer supplied.

## SN54165, SN54LS165A, SN74165, SN74LS165A PARALLEL-LOAD 8-BIT SHIFT REGISTERS

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- Complementary Outputs
- Direct Overriding Load (Data) Inputs
- Gated Clock Inputs
- Parallel-to-Serial Data Conversion

	TYPICAL MAXIMUM	TYPICAL
TYPE	CLOCK FREQUENCY	POWER DISSIPATION
<b>'16</b> 5	26 MHz	210 mW
'LS165A	35 MHz	90 mW

#### description

The '165 and 'LS165A are 8-bit serial shift registers that shift the data in the direction of  $Q_A$  toward  $Q_H$  when clocked. Parallel-in access to each stage is made available by eight individual direct data inputs that are enabled by a low level at the shift/load input. These registers also feature gated clock inputs and complementary outputs from the eighth bit. All inputs are diode-clamped to minimize transmission-line effects, thereby simplifying system design.

Clocking is accomplished through a 2-input positive-NOR gate, permitting one input to be used as a clockinhibit function. Holding either of the clock inputs high inhibits clocking and holding either clock input low with the shift/load input high enables the other clock input. The clock-inhibit input should be changed to the high level only while the clock input is high. Parallel loading is inhibited as long as the shift/load input is high. Data at the parallel inputs are loaded directly into the register while the shift/load input is low independently of the levels of the clock, clock inhibit, or serial inputs.

FUNCTION TABLE

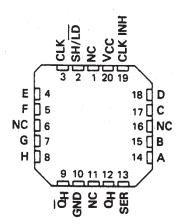
		INPUT	S		INTE	RNAL	
	CLOCK	CLOCK	SERIAL	PARALLEL	ουτ	PUTS	OUTPUT
LOAD	INHIBIT	CLOCK	SERIAL	ΑΗ	ā <sub>A</sub>	QB	QH
L.	X	Х	Х	ah	8	b	h
н	L	. <b>Б</b> .	×	<b>X</b>	0 <sub>A0</sub>	Q <sub>B0</sub>	QH0
н	L.	t	н	×	н	QAn	QGn
н	Ľ	Ť	L I	×	L	QAn	QGn
н	н	х	x	x	Q <sub>A0</sub>	Q <sub>B0</sub>	QH0

SN54165, SN54LS165A . . . J OR W PACKAGE SN74165 . . . N PACKAGE SN74LS165A . . . D OR N PACKAGE

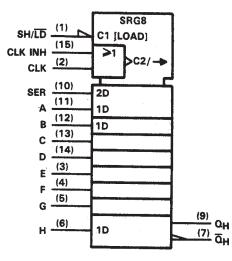
### (TOP VIEW)

SH/LD		$U_{16}$	D٧d	CC
CLK		15		.K INH
E	[]3	14	D	
F.		13	D C	
G	5	12	В	
H	6	11		
	<b>7</b>	10	🗋 SE	ER
GND		9	0	4
	-			

SN54LS165A . . . FK PACKAGE (TOP VIEW)



logic symbol<sup>†</sup>



<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

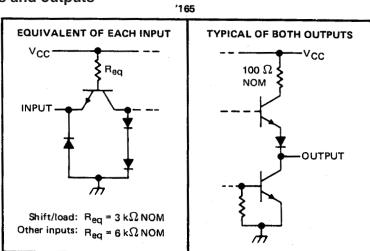
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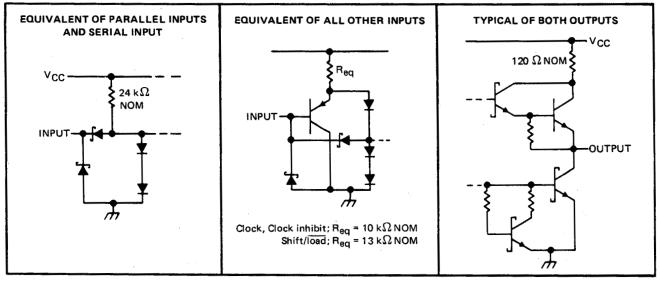
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#### schematics of inputs and outputs

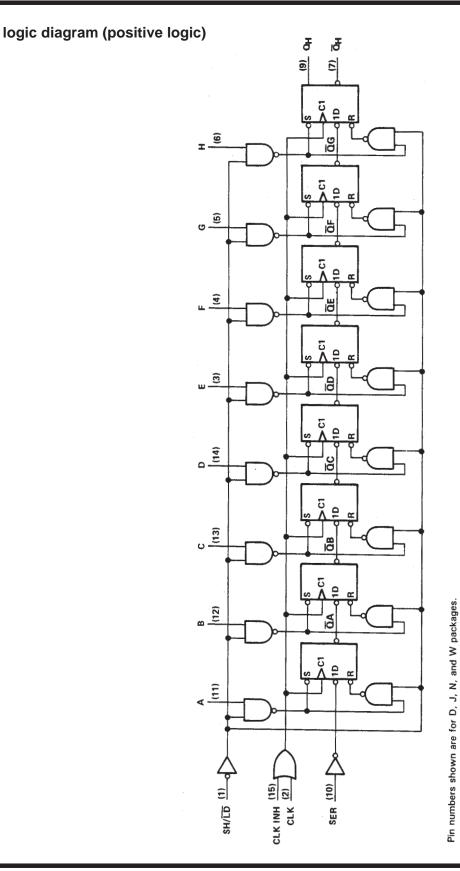








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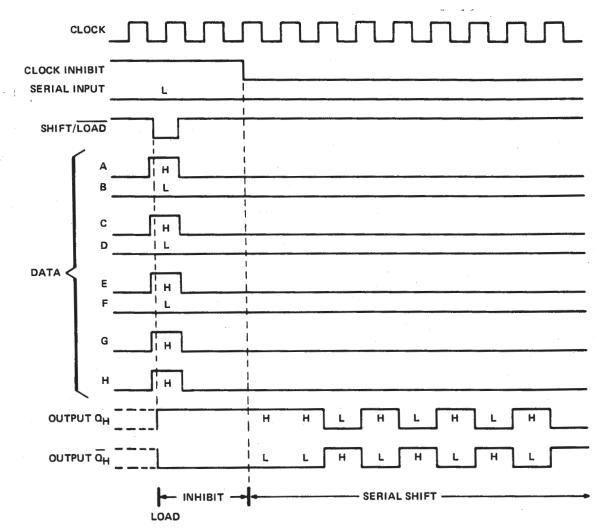


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typical	shift,	load,	and	inhibit	sequences
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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

		-	
Supply voltage, V <sub>CC</sub> (see Note 1)			V
Input voltage: SN54165, SN74165 .			V
SN54LS165A, SN74L	S165A		V
Interemitter voltage (see Note 2)		5.5	V
Operating free-air temperature range:	SN54165, SN54LS165A		C
		$\dots \dots $	
Storage temperature range		$ 65^{\circ}$ C to $150^{\circ}$	°C

NOTES 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.

2. This is the voltage between two emitters of a multiple-emitter transistor. This rating applies for the '165 to the shift/load input in conjunction with the clock-inhibit inputs.



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#### recommended operating conditions

		SN54165 SN74165			UNIT		
,	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-800			-800	μA
Low-level output current, IOL			16			16	mA
Clock frequency, fclock	0		20	0		20	MHz
Width of clock input pulse, tw(clock)	25			25			ns
Width of load input pulse, tw(load)	15			15			ns
Clock-enable setup time, t <sub>su</sub> (see Figure 1)	30			30			ns
Parallel input setup time, t <sub>su</sub> (see Figure 1)	10		-	10			ns
Serial input setup time, t <sub>su</sub> (see Figure 2)	20			20			ns
Shift setup time, t <sub>su</sub> (see Figure 2)	45			45			ns
Hold time at any input, <sup>t</sup> h	0			0			ns
Operating free-air temperature, TA	-55	5	125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CONDITIONS <sup>†</sup>		SN54165			SN74165			UNIT	
	PARAMETER		TEST CO	NDTHONS.	MIN	TYPI	MAX	MIN	TYP‡	MAX	UNIT	
VIH	High-level input voltage				2			2			v	
VIL	Low-level input voltage						0.8			0.8	V	
Vik	Input clamp voltage		V <sub>CC</sub> = MIN,	lj =12 mA			-1.5			-1.5	. V	
Voн	High-level output voltage		V <sub>CC</sub> = MłN, V <sub>IL</sub> = 0.8 V,	V <sub>IH</sub> = 2 V, I <sub>OH</sub> = -800 µA	2.4	3.4		2.4	3.4		v	
VOL	Low-level output voltage	-	V <sub>CC</sub> = MIN, V <sub>IL</sub> = 0.8 V,			0.2	0.4		0.2	0.4	v	
1	Input current at maximum	n input voltage	V <sub>CC</sub> = MAX,	VI = 5.5 V			1			1	mA	
1	High-level input current	Shift/load	V <sub>CC</sub> = MAX, V <sub>1</sub> = 2.4 V				80			80	μA	
ЧН	righ-level input current	Other inputs		v   - 2.4 v			40			40	1 ~	
1	Low-level input current	Shift/load	Vee - MAX	V. = 0.4.V	T		-3.2			-3.2	mA	
ΊL	Low-level input current	Other input current	$V_{CC} = MAX, V_I = 0.4 V$				-1.6			-1.6	\$] <sup>ma</sup>	
los	Short-circuit output curre	ent§	V <sub>CC</sub> = MAX		-20		-55	-18		-55	mA	
1CC	Supply current		VCC = MAX,	See Note 3		42	63		42	63	mA	

NOTE 3: With the outputs open, clock inhibit and clock at 4.5 V, and a clock pulse applied to the shift/load input, I<sub>CC</sub> is measured first with the parallel inputs at 4.5 V, then with the parallel inputs grounded.

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

 $\S{\rm Not}$  more than one output should be shorted at a time.

### switching characteristics, SN54165 and SN74165, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 $^{\circ}$ C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	түр	MAX	UNIT
fmax				20	26		MHz
<sup>t</sup> PLH	Load	Any			21	31	
<sup>t</sup> PHL	Clock	Any			27	40	ns
<sup>t</sup> PLH		Any Q <sub>H</sub>	$C_{1} = 15 \text{ pc} = R_{1} = 400 \text{ (})$		16	24	
1PHL	CIUCK		$C_L = 15 \text{ pF}, R_L = 400 \Omega,$ See figures 1 thru 3		21	31	ns
<sup>t</sup> PLH	н				11	17	
<sup>t</sup> PHL					24	36	ns
<sup>t</sup> PLH	н н	н Фн			18	27	
<sup>t</sup> PHL	п	UH .			18	27	ns

¶f<sub>max</sub> = maximum clock frequency

 $t_{PLH} \equiv$  propagation delay time, low-to-high-level output

tPHL = propagation delay time, high-to-low-level output



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#### recommended operating conditions

			SN54	4LS165/	A	SN74LS165A		UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.7			0.8	V
ЮН	High-level output current				-0.4			-0.4	mA
IOL	Low-level output current				4			8	mA
fclock	Clock frequency		0		25	0		25	MHz
1	Width of clock input pulse (See Figure 1)	clock high	15			15			ns
tw(clock)	which of clock input pulse (See Figure 1)	clock low	25			25			
A (100d)	Midth of load insuit sules	clock high	25			25			ns
t <sub>w</sub> (load)	Width of load input pulse	clock low	17			17			115
t <sub>su</sub>	Clock-enable setup time (See Figure 1)		30			30			ns
t <sub>su</sub>	Parallel input setup time (See Figure 1)		10			10			ns
t <sub>su</sub>	Serial input setup time (See Figure 2)		20			20			ns
t <sub>su</sub>	Shift setup time (See Figure 2)		45			45			ns
th	Hold time at any input		0			0			ns
TA	Operating free-air temperature		- 55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEAT CONDITIONS		SN54LS165A			SN	UNIT		
PARAMETER	TEST CONDITIONS	TEST CONDITIONS			MAX	MIN	TYP‡	MAX	UNIT
VIK	$V_{CC} = MIN$ , $I_I = -18 \text{ mA}$				- 1.5			- 1.5	V
∨он	$V_{CC} = MIN, V_{1H} = 2V, V_{1L} = I_{OH} = -0.4 \text{ mA}$	MAX,	2.5	3.5		2.7	3.5		V
N.	V <sub>CC</sub> = MIN V <sub>1H</sub> = 2 V	$1_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	v
VOL	VIL = MAX,	1 <sub>OL</sub> = 8 mA					0.35	0.5	Ň
۱ <sub>۱</sub>	$V_{CC} = MAX, V_I = 7V$				0.1			0.1	mA
ЧΗ	$V_{CC} = MAX, V_1 = 2.7 V$				20			20	μA
11L	V <sub>CC</sub> = MAX, V <sub>1</sub> = 0.4 V				- 0.4			- 0.4	mA
IOS §	V <sub>CC</sub> = MAX		- 20		- 100	- 20		- 100	mA
<sup>I</sup> CC	V <sub>CC</sub> = MAX, See Note 3			18	30		18	30	mA

NOTE 3: With the outputs open, clock inhibit and clock at 4.5 V, and a clock pulse applied to the shift load input, I<sub>CC</sub> is measured first with the parallel inputs at 4.5 V, then with the parallel inputs grounded.

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $\ddagger$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

### switching characteristics, SN54LS165A and SN74LS165A, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25° C

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
fmax				25	35		MHz
<sup>t</sup> PLH	Load	A 94			21	35	
<sup>t</sup> PHL	Load	ad Any			26	35	ns
<sup>t</sup> PLH	Clock	Any.	$R_L = 2 k\Omega$ , $C_L = 15 pF$		14	25	ns
<sup>t</sup> PHL	CIOCK	Ally.	See Figures 1 thru 3		16	25	
<sup>t</sup> PLH	н	0			13	25	
<sup>t</sup> PHL	CT .	ФH			24	30	ns
<sup>t</sup> PLH	н	а́н			19	30	
<sup>t</sup> PHL		Ч			17	25	ns

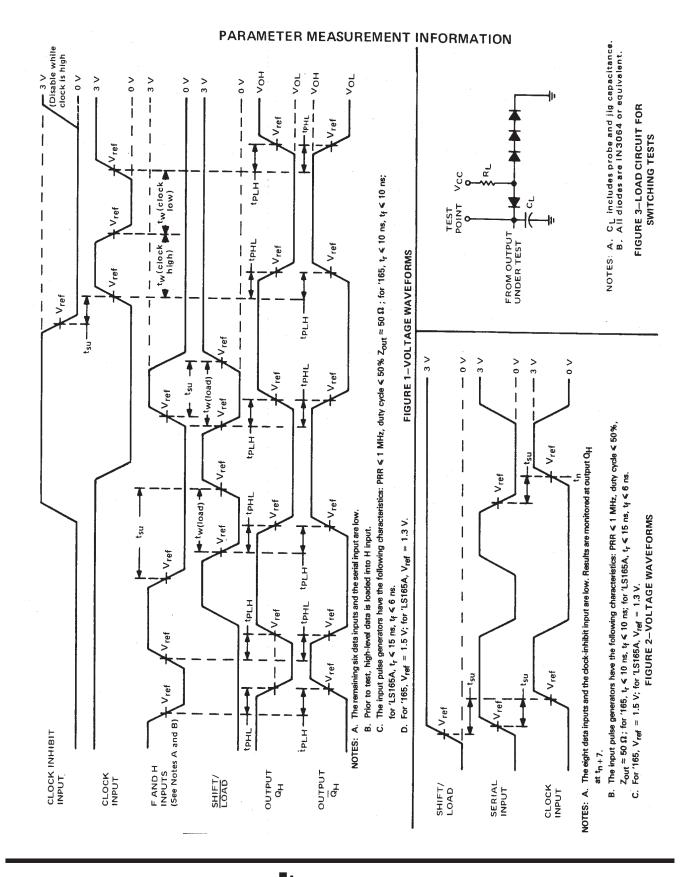
fmax = maximum clock frequency

tPLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output



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